# BMP085 Digital pressure sensor

## Data sheet

**Bosch Sensortec** 





## BMP085 Data sheet

Order code 0 273 300 144

Package type LCC8

Data sheet revision 1.1

Release date 06 April 2009

Document number BST-BMP085-DS000-04

Notes The BMP085 digital pressure sensor is functionally compatible to the existing Bosch Sensortec SMD500 digital pressure sensor. Product photos and pictures are for

illustration purposes only and may differ from the real product's appearance.

Specifications are subject to change without notice.



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## BMP085 Digital pressure sensor

**Key features** 

Pressure range: 300 ... 1100hPa (+9000m ... -500m above sea level)

Supply voltage: 1.8 ... 3.6V (V<sub>DDA</sub>)

1.62V ... 3.6V (V<sub>DDD</sub>)

LCC8 package: Robust, ceramic lead-less chip carrier (LCC) package

Small footprint: 5.0mm x 5.0mm Super-flat: 1.2mm height

Low power:  $5\mu A$  at 1 sample / sec. in standard mode

Low noise: 0.06hPa (0.5m) in ultra low power mode

0.03hPa (0.25m) ultra high resolution mode

**BMP085** 

**SMD500** 

down to 0.1m (rms noise) possible

- Temperature measurement included

- I<sup>2</sup>C interface

- Fully calibrated

- Pb-free, halogen-free and RoHS compliant,

- MSL 1

#### New features comparison

	D.1 000	0.1
Smaller package height	1.2mm	1.55mm
Faster conversion time (standard mode each)	7.5ms (max.)	34ms
Faster I <sup>2</sup> C data transfer	max. 3.4MHz	max. 400kHz
Extended min. supply voltage	min. 1.8V	min. 2.2V
Lower stand-by current (typ.)	0.1μΑ	0.7μΑ
External clock	not necessary	necessary

## **Typical applications**

- Enhancement of GPS navigation (dead-reckoning, slope detection, etc.)
- In- and out-door navigation
- Leisure and sports
- Weather forecast
- · Vertical velocity indication (rise/sink speed)



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#### BMB085 general description

The BMP085 is the fully pin- and function compatible successor of the SMD500, a new generation of high precision digital pressure sensors for consumer applications. The universal C-code SMD500/BMP085 ("BMP085\_SMD500\_API") is fully upward compatible to SMD500 and recognizes automatically the device ID. Customers already working with the SMD500 pressure sensor are invited to contact Bosch Sensortec as soon as they intend to switch-over to the BMP085 sensor for getting first-hand support.

The ultra-low power, low voltage electronics of the BMP085 is optimized for use in mobile phones, PDAs, GPS navigation devices and outdoor equipment. With a low altitude noise of merely 0.25m at fast conversion time, the BMP085 offers superior performance. The I<sup>2</sup>C interface allows for easy system integration with a microcontroller.

The BMP085 is based on piezo-resistive technology for EMC robustness, high accuracy and linearity as well as long term stability.

Robert Bosch is the world market leader for pressure sensors in automotive applications. Based on the experience of over 200 million pressure sensors in the field, the BMP085 continues a new generation of micro-machined pressure sensors.

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#### 1 Electrical characteristics

If not stated otherwise, the given values are maximum values over temperature/voltage range in the given operation mode.

Parameter	Symbol	Condition	Min	Тур	Max	Units
On a ratio a tampo a ratura	т	operational	-40		+85	°C
Operating temperature	$T_A$	full accuracy	0		+65	
Supply voltage $V_{DD}$ $V_{DDIO}$		ripple max. 50mVpp	1.8	2.5	3.6	V
			1.62	2.5	3.6	V
	I <sub>DDLOW</sub>	ultra low power mode		3		μΑ
Supply current @ 1 sample / sec.	I <sub>DDSTD</sub>	standard mode		5		μΑ
25°C	$I_{\rm DDHR}$	high resolution mode		7		μΑ
	I <sub>DDUHR</sub>	ultra high res. mode		12		μΑ
Peak current	l <sub>peak</sub>	during conversion		650	1000	μΑ
Standby current	I <sub>DDSBM</sub>	at 25°C		0.1		μΑ
Serial data clock	$f_{SCL}$				3.4	MHz
Conversion time temperature	$t_{C\_temp}$	standard mode		3	4.5	ms
	t <sub>c_p_low</sub>	ultra low power mode		3	4.5	ms
Conversion time	t <sub>c_p_std</sub>	standard mode		5	7.5	ms
pressure	$t_{c\_p\_hr}$	high resolution mode		9	13.5	ms
	$t_{c_p_luhr}$	ultra high res. mode		17	25.5	ms
Absolute a course		700 1100 hPa 0 +65 °C	-2.5	±1.0	+2.5	hPa
Absolute accuracy pressure		300 700 hPa 0 +65 °C	-3.0	±1.0	+3.0	hPa
V <sub>DD</sub> = 3.3V		300 1100 hPa -20 0 °C	-4.0	±1.5	+4.0	hPa
Resolution of		pressure		0.01		hPa
output data		temperature		0.1		°C
Relative accuracy pressure		700 1100 hPa @ 25 °C		±0.2		hPa
V <sub>DD</sub> = 3.3V		0 65 °C @ p const.		±0.5		hPa
Noise in pressure		Se	ee table on	page 10	<u> </u>	1
Absolute accuracy		@ 25 °C	-1.5	±0.5	+1.5	°C
temperature V <sub>DD</sub> = 3.3V		0 +65 °C	-2.0	±1.0	+2.0	°C

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Solder drifts	Minimum solder height 50µm	±1.0	hPa
Long term stability	12 months	±1.0	hPa

## 2 Absolute maximum ratings

Parameter	Condition	Min	Max	Units
Storage temperature		-40	+85	°C
Supply voltage	all pins	-0.3	+4.25	V
ESD rating	HBM, R = 1.5kΩ, C = 100pF		±2	kV
Overpressure			10,000	hPa





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#### 3 Operation

#### 3.1 General description

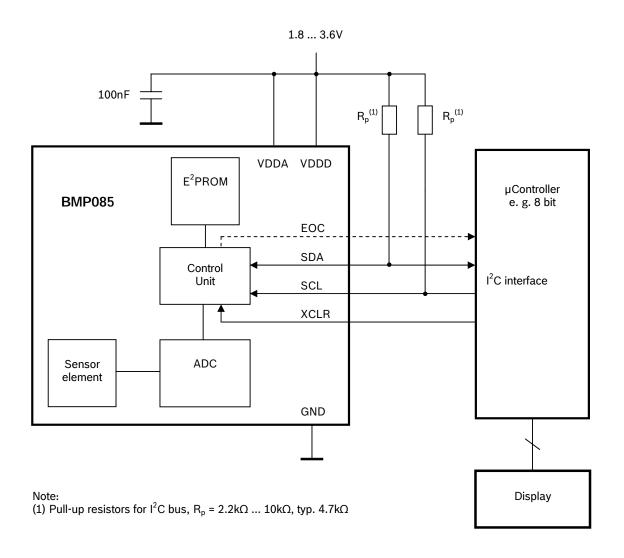
The BMP085 is designed to be connected directly to a microcontroller of a mobile device via the  $I^2C$  bus. The pressure and temperature data has to be compensated by the calibration data of the  $E^2PROM$  of the BMP085.

## 3.2 General function and application schematics

The BMP085 consists of a piezo-resistive sensor, an analog to digital converter and a control unit with  $E^2PROM$  and a serial  $I^2C$  interface. The BMP085 delivers the uncompensated value of pressure and temperature. The  $E^2PROM$  has stored 176 bit of individual calibration data. This is used to compensate offset, temperature dependence and other parameters of the sensor.

- UP = pressure data (16 to 19 bit)
- UT = temperature data (16 bit)

#### Typical application circuit:



#### Note:

The BMP085 can be supplied independently with different levels of  $V_{DDA}$  and  $V_{DDD}$ , which is not possible with the SMD500. In case of different voltage levels,  $V_{DDA}$  and  $V_{DDD}$  shall have a 100nF decoupling capacitor each.

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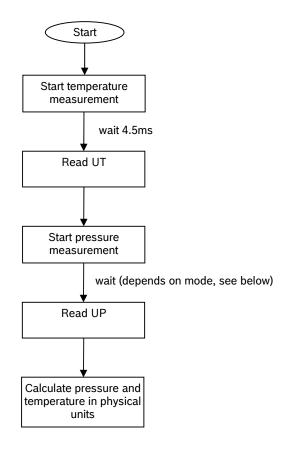
#### 3.3 Measurement of pressure and temperature

For all calculations presented here an ANSI C code is available from Bosch Sensortec ("BMP085\_SMD500\_API").

The microcontroller sends a start sequence to start a pressure or temperature measurement. After converting time, the result value (UP or UT, respectively) can be read via the  $I^2C$  interface. For calculating temperature in  ${}^{\circ}C$  and pressure in hPa, the calibration data has to be used. These constants can be read out from the BMP085  $E^2PROM$  via the  $I^2C$  interface at software initialization.

The sampling rate can be increased up to 128 samples per second (standard mode) for dynamic measurement. In this case, it is sufficient to measure the temperature only once per second and to use this value for all pressure measurements during the same period.

By using different modes the optimum compromise between power consumption, speed and resolution can be selected, see below table.

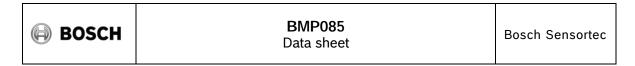


Overview of BMP085 modes, selected by driver software via the variable oversampling\_setting:

Mode	Parameter oversampling_setting	Internal number of samples	Conversion time pressure max. [ms]	Avg. current @ 1 sample/s typ. [μΑ]	RMS noise typ. [hPa]	RMS noise typ. [m]
ultra low power	0	1	4.5	3	0.06	0.5
standard	1	2	7.5	5	0.05	0.4
high resolution	2	4	13.5	7	0.04	0.3
ultra high resolution	3	8	25.5	12	0.03	0.25

The noise data is calculated as standard deviation of 10 data points. For further information on noise characteristics see the relevant application note "Noise in pressure sensor applications".

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All modes can be performed at higher speeds, e.g. up to 128 times per second for standard mode, with the current consumption increasing proportionally to the sample rate. This way the noise can be decreased further by software averaging.

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#### 3.4 Calibration coefficients

The 176 bit  $E^2PROM$  is partitioned in 11 words of 16 bit each. These contain 11 calibration coefficients. Every sensor module has individual coefficients. Before the first calculation of temperature and pressure, the master reads out the  $E^2PROM$  data.

The data communication can be checked by checking that none of the words has the value 0 or 0xFFFF.

	BMP085 reg adr				
Parameter	MSB	LSB			
AC1	0xAA	0xAB			
AC2	0xAC	0xAD			
AC3	0xAE	0xAF			
AC4	0xB0	0xB1			
AC5	0xB2	0xB3			
AC6	0xB4	0xB5			
B1	0xB6	0xB7			
B2	0xB8	0xB9			
MB	0xBA	0xBB			
MC	0xBC	0xBD			
MD	0xBE	0xBF			

#### 3.5 Calculating pressure and temperature

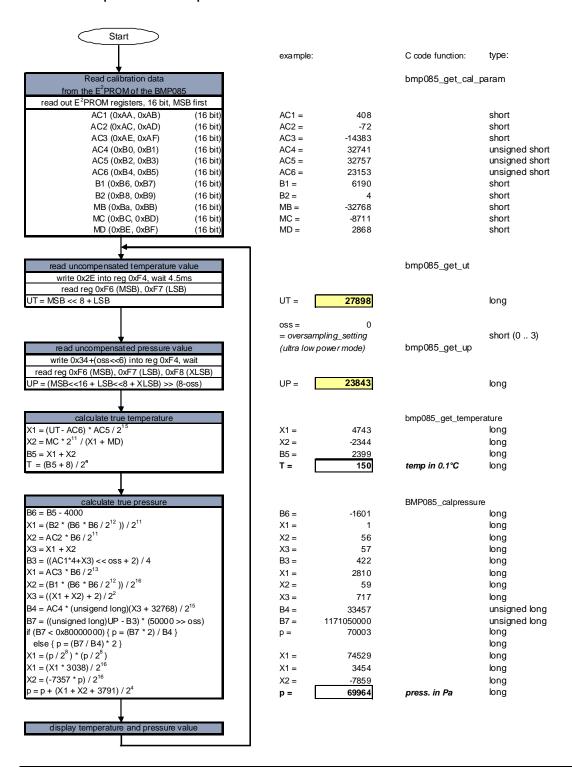
The mode (ultra low power, standard, high, ultra high resolution) can be selected by the variable *oversampling\_setting* (0, 1, 2, 3) in the C code.

The universal code SMD500/BMP085 is fully upward compatible to SMD500 and recognizes automatically the device ID. Thus, the SMD500 can be replaced "on the fly" by the BMP085 without changing hardware or software.

Calculation of true temperature and pressure in steps of 1Pa (= 0.01hPa = 0.01mbar) and temperature in steps of 0.1°C.

The following figure shows the detailed algorithm for pressure and temperature measurement. The algorithm is available as C source code ("BMP085\_SMD500\_API") from Bosch Sensortec.

#### Calculation of pressure and temperature for BMP085



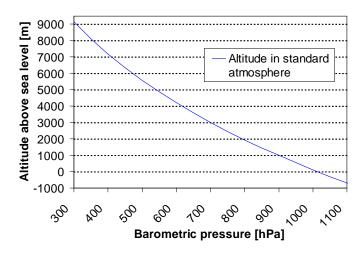
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#### 3.6 Calculating absolute altitude

With the measured pressure p and the pressure at sea level  $p_0$  e.g. 1013.25hPa, the altitude in meters can be calculated with the international barometric formula:

altitude = 44330 \* 
$$\left(1 - \left(\frac{p}{p_0}\right)^{\frac{1}{5.255}}\right)$$

Thus, a pressure change of  $\Delta p$  = 1hPa corresponds to 8.43m at sea level



#### 3.7 Calculating pressure at sea level

With the measured pressure p and the absolute altitude the pressure at sea level can be calculated:

$$p_0 = \frac{p}{\left(1 - \frac{\text{altitude}}{44330}\right)^{5.255}}$$

Thus, a difference in altitude of  $\Delta$ altitude = 10m corresponds to 1.2hPa pressure change at sea level.



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#### 4 I<sup>2</sup>C Interface

- I<sup>2</sup>C is a digital two wire interface
- Clock frequencies up to 3.4Mbit/sec. (I<sup>2</sup>C standard, fast and high-speed mode supported)
- SCL and SDA needs a pull-up resistor, typ. 4.7kOhm to V<sub>DDD</sub> (one resistor each for all the I<sup>2</sup>C bus)

The  $I^2C$  bus is used to control the sensor, to read calibration data from the  $E^2PROM$  and to read the measurement data when A/D conversion is finished. SDA (serial data) and SCL (serial clock) have open-drain outputs.

For detailed I<sup>2</sup>C-bus specification please refer to: http://www.nxp.com/acrobat\_download/literature/9398/39340011.pdf

The BMP085 has a master clear (XCLR) low-active input that is used to reset the BMP085 and initializes internal registers and counters. The device is automatically reset by power on reset (POR) circuitry. XCLR can be left floating if not used. The pad has an internal pull-up resistor of typ. 120kOhm.

#### 4.1 I<sup>2</sup>C specification

Electrical parameters for the I<sup>2</sup>C interface:

Parameter	Symbol	Min.	Тур	Max.	Units
Clock input frequency	f <sub>SCL</sub>			3.4	MHz
Input-low level	V <sub>IL</sub>	0		0.2 * V <sub>DDD</sub>	V
Input-high level	V <sub>IH</sub>	0.8 * V <sub>DDD</sub>		$V_{DDD}$	V
SDA and SCL pull-up resistor	R <sub>pull-up</sub>	2.2		10	kOhm
SDA sink current @ V <sub>DDD</sub> = 1.62V, V <sub>OL</sub> = 0.3V	I <sub>SDA_sink</sub>		9		mA
EOC sink current @ V <sub>DDD</sub> = 1.62V, V <sub>OL</sub> = 0.3V	I <sub>SDA_sink</sub>		7.7		mA
EOC source current @ V <sub>DDD</sub> = 1.62V, V <sub>OH</sub> = 1.32V	I <sub>SDA_source</sub>		1.5		mA
XCLR pulse length	t <sub>XCLR</sub>	1			μs
Start-up time after power-up, before first communication	t <sub>Start</sub>	10			ms



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#### 4.2 Device and register address

The BMP085 module address is shown below. The LSB of the device address distinguishes between read (1) and write (0) operation, corresponding to address 0xEF (read) and 0xEE (write).

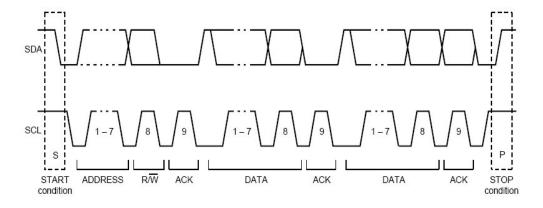
I	A7	A6	A5	A4	A3	A2	A1	W/R
I	1	1	1	0	1	1	1	0/1

There is an easy way to connect two BMP085 to the same I<sup>2</sup>C bus: You can use the XCLR input of BMP085 to set one BMP085 part silent while you communicate with the other BMP085 part via I<sup>2</sup>C and vice versa. The signals can be provided by two digital outputs of the microcontroller, or one digital output and one inverter.

## 4.3 I<sup>2</sup>C protocol

The I<sup>2</sup>C interface protocol has special bus signal conditions. Start (S), stop (P) and binary data conditions are shown below. At start condition, SCL is high and SDA has a falling edge. Then the slave address is sent. After the 7 address bits, the direction control bit R/W selects the read or write operation. When a slave device recognizes that it is being addressed, it should acknowledge by pulling SDA low in the ninth SCL (ACK) cycle.

At stop condition, SCL is also high, but SDA has a rising edge. Data must be held stable at SDA when SCL is high. Data can change value at SDA only when SCL is low.

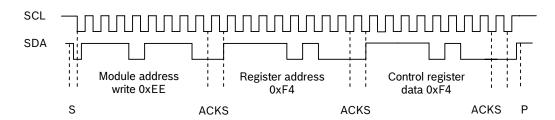




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#### 4.4 Start temperature and pressure measurement

The timing diagrams to start the measurement of the temperature value UT and pressure value UP are shown below. After start condition the master sends the device address write, the register address and the control register data. The BMP085 sends an acknowledgement (ACKS) every 8 data bits when data is received. The master sends a stop condition after the last ACKS.



Timing diagram for starting pressure measurement

Abbreviations:

S Start P Stop

ACKS Acknowledge by Slave
ACKM Acknowledge by Master
NACKM Not Acknowledge by Master

Control registers values for different internal oversampling\_setting (osrs):

Measurement	Control register value (register address 0xF4)	Max. conversion time [ms]
Temperature	0x2E	4.5
Pressure (osrs = 0)	0x34	4.5
Pressure (osrs = 1)	0x74	7.5
Pressure (osrs = 2)	0xB4	13.5
Pressure (osrs = 3)	0xF4	25.5

Instead of waiting for the maximum conversion time, the output pin EOC (end of conversion) can be used to check if the conversion is finished (logic 1) or still running (logic 0). After the conversion is finished BMP085 switches automatically in standby mode.

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#### 4.5 Read A/D conversion result or E<sup>2</sup>PROM data

To read out the temperature data word UT (16 bit), the pressure data word UP (16 to 19 bit) and the E<sup>2</sup>PROM data proceed as follows:

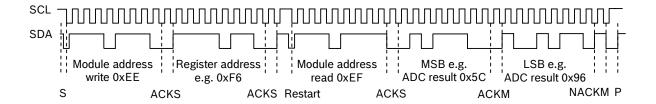
After the start condition the master sends the module address write command and register address. The register address selects the read register:

E<sup>2</sup>PROM data registers 0xAA to 0xBF Temperature or pressure value UT or UP 0xF6 (MSB), 0xF7 (LSB), optionally 0xF8 (XLSB)

Then the master sends a restart condition followed by the module address read that will be acknowledged by the BMP085 (ACKS). The BMP085 sends first the 8 MSB, acknowledged by the master (ACKM), then the 8 LSB. The master sends a "not acknowledge" (NACKM) and finally a stop condition.

Optionally for ultra high resolution, the XLSB register with address 0xF8 can be read to extend the 16 bit word to up to 19 bits; refer to the application programming interface (API) software rev. 1.1 ("BMP085\_SMD500\_API", available from Bosch Sensortec).

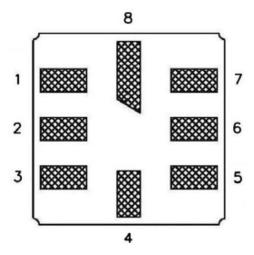
Timing diagram read 16 bit A/D conversion result:



## 5 Package

## 5.1 Pin configuration

Picture shows the device in top view. Device pins are shown here transparently only for orientation purposes.



Pin No.	Name	Function	Туре
1	GND	Ground	Power
2	EOC	End of conversion	Digital output
3	$V_{DDA}$	Power supply	Power
4	$V_{DDD}$	Digital power supply	Power
5	NC	no internal connection	-
6	SCL	I <sup>2</sup> C serial bus clock input	Digital input
7	SDA	I <sup>2</sup> C serial bus data	Digital bi-directional
8	XCLR	master clear (low active) input	Digital input

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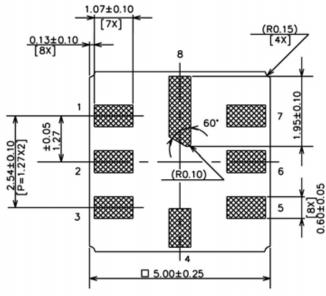
#### 5.2 Outline dimensions

The sensor housing is a standard 8-pin lead-less chip carrier (LCC8) ceramic package. Its dimensions are  $5.0 \text{mm} \times 5.0 \text{mm} (\pm 0.25 \text{mm}) \times 1.2 \text{mm} (\pm 0.12 \text{mm})$ . Package weight is approximately 0.09 grams.

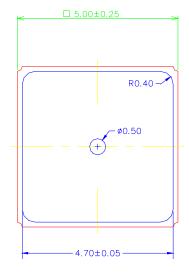
Note: All dimensions are in mm.

#### 5.2.1 Top view

Device pins are shown here transparently only for orientation purposes.



## 5.2.2 Top view with lid



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#### 5.2.3 Side view with lid

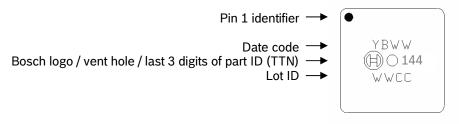




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#### 5.3 Device marking

The device lid shows the following laser-marking:

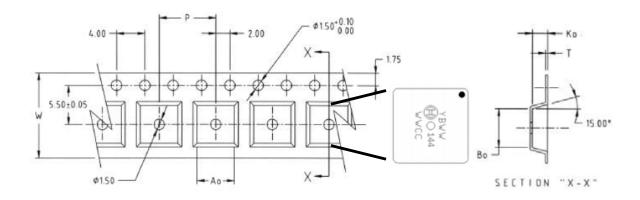


The vent hole (diameter 0.5mm) is in the center of the lid, between the Bosch logo and the part ID code (144).

## 5.4 Tape on reel

Number of parts per reel: 3,000

Orientation of the parts inside the reel is according to EN60286-3.



Carrier tape material: Conductive polystyrene C 100, 10<sup>3</sup> – 10<sup>6</sup> Ohm/sq.

Dimensions are in mm:

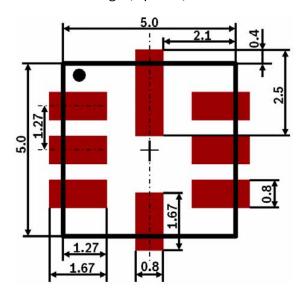
 $\begin{array}{lll} A_0 &=& 5.30 \pm 0.10 \\ B_0 &=& 5.30 \pm 0.10 \\ K_0 &=& 2.10 \pm 0.10 \\ P &=& 8.00 \pm 0.10 \\ W &=& 12.00 + 0.30 \slash -0.10 \\ t &=& 0.30 \pm 0.05 \end{array}$ 

The bars between the cavities are embossed about 0.2mm into the direction of  $K_0$ . All other dimensions and tolerances follow the EIA 481 standard.

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#### 5.5 Printed circuit board (PCB) design

Recommended PCB design (top view):



## 5.6 Moisture sensitivity level and soldering

The BMP085 is classified MSL 1 (moisture sensitivity level) according to IPC/JEDEC standards J-STD-020D and J-STD-033A.

The device can be soldered Pb-free with a peak temperature of 260°C for 20 to 40 sec. The minimum height of the solder after reflow shall be at least  $50\mu m$ . This is required for good mechanical decoupling between the sensor device and the printed circuit board (PCB).

The BMP085 devices have to be soldered within 6 months after shipment (shelf life). To ensure good solder-ability, the devices shall be stored at room temperature (20°C).

The soldering process can lead to an offset shift of typically 1hPa.



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#### 5.7 RoHS compliancy

The BMP085 sensor meets the requirements of the EC directive "Restriction of hazardous substances (RoHS)", please refer also to:

"Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment".

The BMP085 sensor is also halogen-free. Please contact your Bosch Sensortec representative for the corresponding analysis report.



## 5.8 Mounting and assembly recommendations

Please read the following recommendations carefully:

- The clearance above the metal lid shall be 0.1mm at minimum.
- For the device housing appropriate venting needs to be provided in case the ambient pressure shall be measured. If waterproof packaging is needed, venting can be accomplished by a vent element with a membrane like Gore-Tex<sup>(TM)</sup>.
- Liquids shall not come into direct contact with the device.
- During operation the sensor is sensitive to light, which can influence the accuracy of the measurement (photo-current of silicon). Therefore, the hole in the top lid shall not be exposed to direct light during operation.
- The BMP085 shall not the placed close the fast heating parts. In case of gradients > 3°C/sec. it is recommended to follow Bosch Sensortec application note ANP015, "Correction of errors induced by fast temperature changes". Please contact your Bosch Sensortec representative for details.
- For further details, please refer to the BMP085 handling, soldering & mounting instructions manual that is also available from Bosch Sensortec.



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#### 6 Legal disclaimer

#### 6.1 Engineering samples

Engineering Samples are marked with an asterisk (\*) or (e). Samples may vary from the valid technical specifications of the product series contained in this data sheet. They are therefore not intended or fit for resale to third parties or for use in end products. Their sole purpose is internal client testing. The testing of an engineering sample may in no way replace the testing of a product series. Bosch Sensortec assumes no liability for the use of engineering samples. The Purchaser shall indemnify Bosch Sensortec from all claims arising from the use of engineering samples.

#### 6.2 Product use

Bosch Sensortec products are developed for the consumer goods industry. They may only be used within the parameters of this product data sheet. They are not fit for use in life-sustaining or security sensitive systems. Security sensitive systems are those for which a malfunction is expected to lead to bodily harm or significant property damage. In addition, they are not fit for use in products which interact with motor vehicle systems.

The resale and/or use of products are at the purchaser's own risk and his own responsibility. The examination of fitness for the intended use is the sole responsibility of the Purchaser.

The purchaser shall indemnify Bosch Sensortec from all third party claims arising from any product use not covered by the parameters of this product data sheet or not approved by Bosch Sensortec and reimburse Bosch Sensortec for all costs in connection with such claims.

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#### 6.3 Application examples and hints

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## 7 Document history and modifications

Rev. No	Chapter	Description of modifications/changes	Date	
0.1		First edition for description of serial production		
		material		
0.2		Noise data update, peak current added, several minor	19-Feb-2008	
		changes	13-160-2000	
0.3	1	Update peak current, typo correction	21-Apr-2008	
	1	Changed $V_{DDA}$ to $V_{DD}$ and $V_{DDD}$ to $V_{DDIO}$	21-Apr-2008	
	3.5	Updated flow diagram	21-Apr-2008	
	4	New comment on floating XCLR	21-Apr-2008	
	4.1	Added details on start-up time	21-Apr-2008	
	5.2	Added package weight	21-Apr-2008	
1.0	1	Absolute accuracy at -20°C added	01-July-2008	
	2	Updated storage temperature	01-July-2008	
	3.2	Added optional EOC to schematic	01-July-2008	
	5.7	BMP085 is halogen-free	01-July-2008	
1.1	3.3	Added comment on noise data calculation	06-April-2009	
	3.5	Variable type of B7 is unsigned long		
	4	Added comment on low active master clear and		
	4	120kOhms pull-up resistor		
	4.2	Added solution to connect two devices BMP085 to		
		the same I2C bus.		
	4.4	Added remark about automatic standby-mode		
	5.6	JEDEC J-STD-020D		
	5.5	Updated or recommended PCB-design picture		
	5.8	Explained that light sensitivity is only during operation		

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